

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Masaaki Yamasaki</td> <td>06/07/2007</td> </tr> <tr> <td>Toshihide Sekido</td> <td>06/07/2007</td> </tr> <tr> <td>Hidehiro Takemoto</td> <td>06/07/2007</td> </tr> </tbody> </table>		Name	Execution Date	Masaaki Yamasaki	06/07/2007	Toshihide Sekido	06/07/2007	Hidehiro Takemoto	06/07/2007
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Masaaki Yamasaki	06/07/2007								
Toshihide Sekido	06/07/2007								
Hidehiro Takemoto	06/07/2007								
RECEIVING PARTY DATA									
Name:	Toray Industries, Inc.								
Street Address:	1-1 Nihonbashi-Muromachi 2-chome								
Internal Address:	Chuo-ku								
City:	Tokyo								
State/Country:	JAPAN								
Postal Code:	103-8666								
PROPERTY NUMBERS Total: 1									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11792128</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11792128				
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CORRESPONDENCE DATA									
Fax Number:	(215)656-2498								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
Phone:	215-656-3381								
Email:	ip.phil@dlapiper.com								
Correspondent Name:	T.Daniel Christenbury								
Address Line 1:	One Liberty Place								
Address Line 2:	1650 Market Street, Suite 4900								
Address Line 4:	Philadelphia, PENNSYLVANIA 19103								
ATTORNEY DOCKET NUMBER:	TIP-07-1145 308877-208								
NAME OF SUBMITTER:	Carol Coney								

CH \$40.00 11792128

Total Attachments: 1
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ASSIGNMENT

WHEREAS, We, Masaaki YAMASAKI, Toshihide SEKIDO and Hidehiro TAKEMOTO, citizens of Japan, residing at Toray-Setoryo, 1456, Tsutui, Masakicho, Iyo-gun, Ehime 7913120 Japan; 8-40-704, Nagara 2-chome, Otsu-shi, Shiga 5200046 Japan and Toray-Shataku 2-3, 1451, Tsutsui, Masakicho, Iyo-gun, Ehime 7913120 Japan respectively, (hereinafter referred to as "the undersigned"), having made an invention entitled MOLDING PRECURSOR, PROCESS FOR PRODUCING MOLDED FIBER-REINFORCED RESIN, AND MOLDED FIBER-REINFORCED RESIN for which on the date set forth below, unless otherwise indicated here, _____, the undersigned executed an application for United States Letters Patent,

WHEREAS, Toray Industries, Inc., a corporation of Japan, with offices at 1-1, Nihonbashi-Muromachi 2-chome, Chuo-ku, Tokyo 1038666 Japan, (hereinafter referred to as "assignee"), is desirous of acquiring the entire right, title and interest in said invention, said application and all letters patent issuing for said invention,

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and of other good and valuable consideration, receipt of which is hereby acknowledged, the undersigned, intending to be legally bound, does hereby sell, assign and transfer to the assignee the entire right, title and interest, for the United States of America, its territories and possessions, and for all foreign countries, in said invention, including said patent application, all divisions and continuations thereof, all rights to claim priority based thereon, all rights to file foreign applications on said invention, and all letters patent and reissues thereof, issuing for said invention in the United States of America and in any and all foreign countries.

It is agreed that the undersigned shall be legally bound, upon request of the assignee, or its successors or assigns or a legal representative thereof, to supply all information and evidence of which the undersigned has knowledge or possession, relating to the making and practice of said invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention in the United States of America and foreign countries in the name of the assignee, and to execute all instruments proper to carry out the intent of this instrument. If the undersigned includes more than one individual, these obligations shall apply to all of the undersigned both individually and collectively.

The rights and property herein conveyed by the undersigned are free and clear of any encumbrance.

EXECUTED on June 7, 2007, at Iyo-gun, Ehime.



Masaaki YAMASAKI



Toshihide SEKIDO



Hidehiro TAKEMOTO

Witness